

SFP+ 10GBASE-T Copper RJ-45 30m

Product Features

- ✓ Support 10GBASE-T Operation in Host Systems
- ✓ Support RX_LOS as Link indication function
- ✓ Hot-Pluggable SFP Footprint
- ✓ Compact **RJ-45** Connector Assembly
- ✓ Compliant with SFP MSA
- ✓ Operating Case Temperature:
- ✓ Standard: 0°C~70°C

Applications

- ✓ 10G BASE-T IEEE 802.3an
- √ 1000BASE-T IEEE 802.3ab
- √ 100BASE-TX IEEE 802.3u
- ✓ 5G MGBASE-T
- ✓ 2.5G MGBASE-T

General

10G BASE-T Copper Small Form Pluggable (SFP) modules are based on the SFP Multi Source Agreement (MSA). It is compliant with the 10G BASE-T,1000BASE-T, 100BASE-TX standards as specified in IEEE STD 802.3an, 802.3ab and 802.3au.



SFP to Host Connector Pin Out

PIN	Symbol	Name/Description	Ref.
1	VeeT	Transmitter ground (common with receiver ground)	1
2	TFAULT	Transmitter Fault. Not supported	
3	TDIS	Transmitter Disable. PHY disabled on high or open.	2
4	MOD_DEF(2)	Module Definition 2. Data line for serial ID	3
5	MOD_DEF(1)	Module Definition 1. Clock line for serial ID	3
6	MOD_DEF(0)	Module Definition 0. Grounded within the module.	3
7	Rate Select	No connection required	
8	LOS	Loss of Signal indication	4
9	VeeR	Receiver ground (common with transmitter ground)	1
10	VeeR	Receiver ground (common with transmitter ground)	1
11	VeeR	Receiver ground (common with transmitter ground)	1
12	RD-	Receiver Inverted DATA out. AC coupled	
13	RD+	Receiver Non-inverted DATA out. AC coupled	
14	VeeR	Receiver ground (common with transmitter ground)	1
15	VccR	Receiver Power Supply	
16	VccT	Transmitter power supply	
17	VeeT	Transmitter ground (common with receiver ground)	1
18	TD+	Transmitter Non-Inverted DATA in. AC coupled	
19	TD-	Transmitter Inverted DATA in. AC coupled	
20	VeeT	Transmitter ground (common with receiver ground)	1

Notes:

- 1. Circuit ground is connected to chassis ground
- 2. PHY disabled on TDIS > 2.0V or open, enabled on TDIS < 0.8V
- 3. Should be pulled up with 4.7k 10k Ohms on host board to a voltage between 2.0 V and 3.6V.MOD_DEF(0) pulls line low to indicate module is plugged in.
- 4. LVTTL compatible with a maximum voltage of 2.5V. Not supported on GE-GB-P.



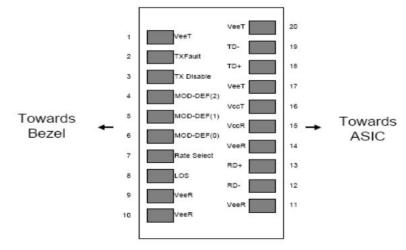


Figure 1. Diagram of host board connector block pin numbers and names

Table 1. SFP to host connector pin assignments and descriptions

+3.3V Volts Electrical Power Interface

The GE-GB-P has an input voltage range of 3.3 V +/- 5%. The 4 V maximum voltage is not allowed for continuous operation.

+3.3 Volt Electrical Power Interface											
Parameter	Symbol	Min	Тур	Max	Units	Notes/Conditions					
Supply	lo		320	375	mA	1.2W max power over full range of voltage and					
Current	ls ls					temperature See caution note below					
Input Voltage	Vcc	3.13	3.3	3.47	V	Referenced to GND					
Maximum Voltage	Vmax			4	V						
Surge Current	Isurge			30	mA	Hot plug above steady statecurrent. See caution note below					

Caution: Power consumption and surge current are higher than the specified values in the SFP MSA

Table 2. +3.3 Volt electrical power interface

Low-Speed Signals

MOD_DEF(1) (SCL) and MOD_DEF(2) (SDA), are open drain CMOS signals (see section VII, "Serial Communication Protocol"). Both MOD_DEF(1) and MOD_DEF(2) must be pulled up to host_Vcc.

Low-Speed Signals, Electronic Characteristics											
Parameter	Parameter Symbol Min Max				Notes/Conditions						
SFP Output	VOL	0	0.5	V	4.7k to 10k pull-up to host_Vcc, measured at						
LOW	VOL	0	0.5	V	host side of connector						
SFP Output	VOH	host_Vcc -	host_Vcc +	V	4.7k to 10k pull-up to host_Vcc, measured at						
HIGH	VOH	0.5	0.3	V	host side of connector						
CED Innuit I OW	VIL	0	0.8	V	4.7k to 10k pull-up to Vcc, measured at SFP side						
SFP Input LOW	VIL	O	0.8	V	of connector						
SED Input UICH	VIH	2	\/aa + 0.2	V	4.7k to 10k pull-up to Vcc, measured at SFP side						
SFP Input HIGH	VIΠ	2	Vcc + 0.3	V	of connector						

Table 3. Low-speed signals, electronic characteristics



High-Speed Electrical Interface

All high-speed signals are AC-coupled internally.

High-Speed Electrical Interface, Transmission Line-SFP										
Parameter	Symbol	Min	Notes/Conditions							
Line Frequency	fL		125	25 MHz		Hz 5-level encoding, per IEEE 802.3				
Tx Output Impedance	' Zout.TX 100 Ohm		Differential, for all Frequencies between 1MHz and 125MHz							
Rx Input Impedance	Zin,RX		100		Ohm	Differential, for all Frequencies between 1MHz and 125MHz				

Table 4. High-speed electrical interface, transmission line-SFP

High-Speed Electrical Interface

Host-SFP										
Parameter	Symbol	Min	Тур	Max	Units	Notes/Conditions				
Single ended data input swing	Vinsing	250		1200	mV	Single ended				
Single ended data output swing	Voutsing	350		800	mV	Single ended				
Rise/Fall Time	Tr,Tf		175		psec	20%-80%				
Tx Input Impedance	Zin		50		Ohm	Single ended				
Rx Output Impedance	Zout		50		Ohm	Single ended				

Table 5. High-speed electrical interface, host-SFP

General Specifications

General											
Parameter Symbol Min Typ Max Units Notes/Conditions											
Data Rate	BR	10		1000	Mb/sec	IEEE 802.3 compatible. See Notes 2 through 4 below					
Cable Length	L			100	m	Category 5 UTP. BER <10-12					

Table 6. General specifications

Notes:

- 1. Clock tolerance is +/- 50 ppm
- 2. By default, the GE-GB-P is a full duplex device in preferred master mode
- 3. Automatic crossover detection is enabled. External crossover cable is not required
- 4. 1000 BASE-T operation requires the host system to have an SGMII interface with no clocks, and the module PHY to be configured per Application Note AN-2036. With a SERDES that does not support SGMII, the module will operate at 1000BASE-T only



Environmental Specifications

This SFP has an extended range from 0°C to +85°C case temperature as specified in Table 8.

Environmental Specifications										
Parameter Symbol Min Typ Max Units Notes/Condition										
Operating Temperature	Тор	0		85	°C	Case temperature				
Storage Temperature	Tsto	-40		85	°C	Ambient temperature				

Table 7. Environmental specifications

Mechanical Specifications

The host-side of this SFP conforms to the mechanical specifications outlined in the SFP MSA1. The front portion of the SFP (part extending beyond the face plate of the host) is larger to accommodate the RJ-45 connector. See Figure 2 below for details.

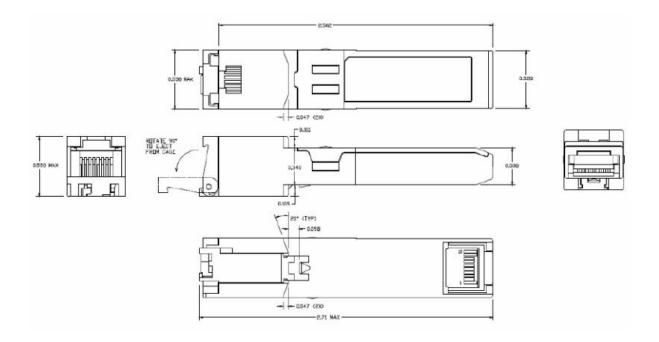


Figure 2. Mechanical dimensions

- 1. Small Form Factor Pluggable (SFP) Transceiver Multi-Source Agreement (MSA),
- 2. IEEE Std 802.3, 2002 Edition. IEEE Standards Department, 2002.
- 3. "AT24C01A/02/04/08/16 2-Wire Serial CMOS E2PROM", Atmel Corporation.